4		
LASTAR Lastar Technolog	NICKEL NICKEL NICKEL	(\$3.50mm 4 POLE PLUG DETAIL DRAWING (\$3.50mm 1 LCP+30%G.F 1 COMMINAL 1 COMMINAL 1 COMMINAL 1 COMMINAL 1 COMMINAL 2u" GOLD/50~80u" (\$) TERMINAL F 1 C2680R-H 0.20T 2u" GOLD/50~80u" (\$) TERMINAL F 1 C2680R-H 0.20T 2u" GOLD/50~80u" (\$) TERMINAL E 1 C17200 290 TM04 0.20T 2u" GOLD/50~80u" (\$) CONTACT C 1 C17200 290 TM04 0.20T 2u" GOLD/50~80u" (\$) CONTACT G 1 C17200 290 TM04 0.20T 2u" GOLD/50~80u" (\$) CONTACT G 1 C5191R-H 0.20T 2u" GOLD/50~80u" (\$) CONTACT H 1 C5210R-EH 0.20T 2u" GOLD/50~80u" (\$) PART NAMERTIAL DESCRIPTION DESCRIPTION
NOTES: 1. REQUEST OF THE SPECIFICATION: 1.1 CONTACT CURRENT RATING: 1A.; 1.2 CONTACT RESISTANCE: 50 m? MAX.; 1.3 INSULATION RESISTANCE: 100M? MIN.; 1.4 DIELECTRIC WITHSTANDING: 500V AC MIN.; 1.5 DURABILITY: 5,000 CYCLES MIN.; 1.6 CONNECTOR MATING FORCES: 2.9.8N (3.00Kgf) MAX.; 1.7 CONNECTOR MATING FORCES: 2.9.8N (0.30Kgf) MIN.; 2. MARKED DIMENSION SHOULD BE MEASURED BY FAI. 3. MARKED DIMENSION SHOULD BE MEASURED BY AIP. 4. UNLESS OTHERWISE SPECIFIED, NO MARKED DIMENSIONS ARE REF. 5. PRODUCT MEET THE REQUEST OF THE ROHS, SEE TABLE A:	SCHEMATIC	¢3.00±0.05 ¢2.50±0.05 0 0 0 0 0 0 0 0 0 0 0 0 0
PCB LAYOUT TOP VIEW		
LOCAS. DESCRIPTION DATE DESIGN RELEASE TO CUSTOMER 130205 HANG	A ECN NO.	0.50±0.20 .20 2.75±0.20 0.50±0.20 .20 .75±0.20 0.50±0.20 .20 .20 .20 .20 .20 .20 .20

	tion ITLE		STATUS	SPEC.	NO.	DAT	Е	PAGE	NO.
2 5 E A DI	PHONE J	ACV	CENEDAL			2012.0	1.05	1//	-
5.5 EAN	TONE J	ACK	GENERAL			2012.0	01.25	1/:	>
EARPHO ESPECIA REFLOW SOLDERI MATED PL THE M	LLY TH ng proc UG ATED PI	K APPLIED IS SPECIF ESS LUG SHO	VERs THE GE ON AUDIO SYSTEM ICATION APPLIE ULD COMPLIED 3 AND 4 POLEs(P	D ON TH WITH ST	ER RELAT IE HIGH FANDARI	TED ELE TEMF	CTRO P. PL	NIC APPAR ASTICFOR	TH
2. MECHAN 2a. TERMINA THE TER DIRECTIO BENDINO	AL STREN MINALs S DN FO	SHALL BE (CAPABLE OF WITH SECONDs WITH						IN ANY EXCEPT
		CONDIT	IONs		VA	ALUE	OF	SPEC.	
	L CONDI					4 Kgs	ТО	3.0 Kgs	
HUMII AFTEF AFTEF	DITY TEST R HEAT TE R COLD TH	EST EST	LDERING HEAT TE	ST	0.3	3 Kgs	ТО	3.0 Kgs	
	CTION FO	DCE							
	LIION FU	CONDIT	IONs		V	ALUE	OF	SPEC.	
INITIA	L CONDI		10115			4 Kgs	TO	3.0 Kgs	
AFTEF HUMII AFTEF AFTEF	LIFE TES DITY TES HEAT TE COLD TH	ST AFTER F EST EST	LDERING HEAT TE	ST		3 Kgs	ТО	3.0 Kgs	
TERMINA 3b. INSULAT THE INSU	ND VOLT AC/RMS Ls FOR 11 ION RESI LATION R	OF COMMI MINUTE WI STANCE ESISTANCI	ERCIAL FREQUENO THOUT BREAKDO E BETWEEN MUTU INDER 250 VOLTs D	WN AL INSULAT	ED CONT	ACTs SH	OULE	O COMPLIE	D WITH
REV. NAME	DATE		REMARK			P Richa V D	rd H K D	Richard R T N	Richard

	TITLE STATUS SP					PEC. NO.	DA	DATE		GE	NO.	
3	3.5 EARPHONE JACK GENERAL						2012	2.01.25			2/5	
CONDITIONS INITIAL CONDITION AFTER LIFE TEST AFTER HEAT TEST AFTER COLD TEST AFTER RESISTANCE TO SOLDERING HEAT TEST							/ALUE 100 1	OF M MIN		PEC.		
AFTER HIMIDITY TEST 50 M MIN.												
NOTE : THE MATED PLUG USED TO THIS MEASUREMENT SHALL BE ALLOWED TO CLEAN AND REMOVE OXIDATION FILM ON THE SURFACE BEFORE TEST.										N AND		
3c. CONTACT RESISTANCE CONTACT RESISTANCE OF JACK SHALL NOT EXCEED THE VALUE DEFINED IN THE TABLE LISTED AT A CURRENT LESS THAN 100 mA WITH FREQUENCY OF 1 KHz BY FOUR TERMINALS METHOD										ISTED AT		
			CONDIT	IONs		VALUE OF SPEC.						
INITIAL CONDITION AFTER HUMIDITY TEST AFTER HEAT TEST AFTER COLD TEST AFTER RESISTANCE TO SOLDERING HEAT TEST						PLUG TO CON 50 ṃ MAX	CONTACT TO SHUNT 30 m MAX.					
	AFTER	DURABI	LITY TEST			100 m MAX	ζ.		60 m	MA	X.	
				JSED TO THIS MEA N FILM ON THE SU				OWED	TO CL	EAN	N AND	
DURA TH WI PEI LO CO TH RE SH MEAS AL 35 STA OT 5. ENV 5a. HI TH THE D TH	TH TH R MIN AD NDITION E DET QUIREM OULD CO SURING L MEA C WIT ANDARD HERWIS TRONM UMIDITY E JACK RELA ROPs HE SUR	TEST BILITY T IE MA UTE, I IAIL ENT. T OMPLY W CONDITI SUREME H A RE OATMOS E SPECIF IENT (TEST SHALL E TIVE ON T FANCE	TED PLU N TH OR HE PERFO /ITH PARACION ON NTS AND CLATIVE PHERIC TED CONDI BE PLACED HUMIDITY THE SURFAC OF JACK	WITHOUT LUB ORMANCE OF GRAPHs 2b AN 3c. TEST SHALL HUMIDITY OF PRESSURE UNL	AUGE RICA FHE BE 45% ESS CHAN CED UTEs	E PLUG AT A NT WHICH JACK BEFOI MADE AT A %RH TO 8 MBER AT THE C 95% RH F L BE BLOWN IN AMBIENT 5, RECOVERY	RATE SHOU RE AN TEMI 5%RH CONDIT OR OR OFF T TEM PERIO	10 JLD JD A PERAT UNE ION O 96 I AND PERA D. TH	~ 20 BE FTER URE DER F 40 ^O Hrs, REM FURE E RE	C SPH TI 10 ⁰ C TH IOVI FC LAT	YCLEs ECIFIED HIS TEST ^D C TO 2 ^O C ANI IE DEW ED FROM DR MORE	
REV.	NAME	DATE		REMARK			P V D		Ric	hare	R T N	

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5b. HEAT TEST

THE JACK SHALL BE PLACED IN THE TESTING CHAMBER AT A TEMPERATURE OF 85 ^OC 2^OC AN THE RELATIVE HUMIDITY OF LESS THAN 50%RH FOR 96 Hrs AND THEN PLACED IN AMBIENT TEMPERATURE FOR MORE THAN 30 MINUTES, RECOVERY PERIOD. THE RELATIVE TEST BEFORE AND AFTER THIS TEST SHOULD COMPLIED WITH PARAGRAPH 3c.

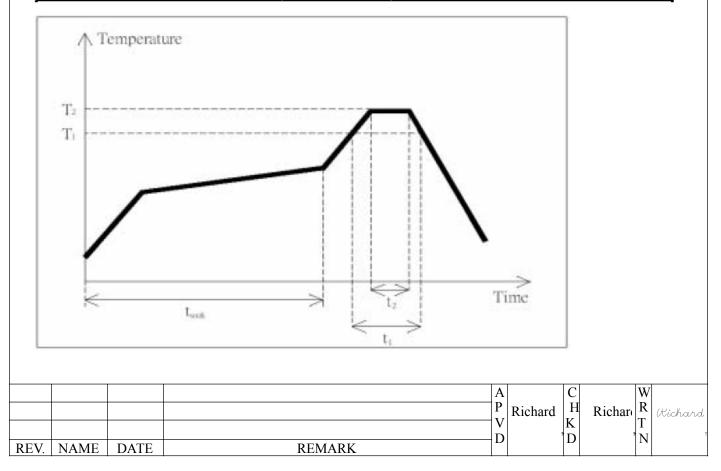
5c. COLD TEST

THE JACK SHALL BE PLACED IN THE TESTING CHAMBER AT A TEMPERATURE OF -40 ^OC 2^OC AND THE RELATIVE HUMIDITY OF LESS THAN 50%RH FOR 96 Hrs AND THEN PLACED IN AMBIENT TEMPERATURE FOR MORE THAN 30 MINUTES, RECOVERY PERIOD. THE RELATIVE TEST BEFORE AND AFTER THIS TEST SHOULD COMPLIED WITH PARAGRAPH 3c.

6. SOLDERING TEST

6.a REFLOW PROFILE FOR SOLDERABILITY TESTING

Reflow profile for solderability Testing:								
Item	Time	Specification						
Pre Heating		<u>≤</u> 3°C/Sec						
Flux Wetting	Tsoak	2~3Min						
Time Over 217℃	t1	≦30Sec						
Peak Temp	T2	230°C(-0/+5°C)						
Peak Time	t2	10Sec						
Speed of Cooling		<6°C/Sec						

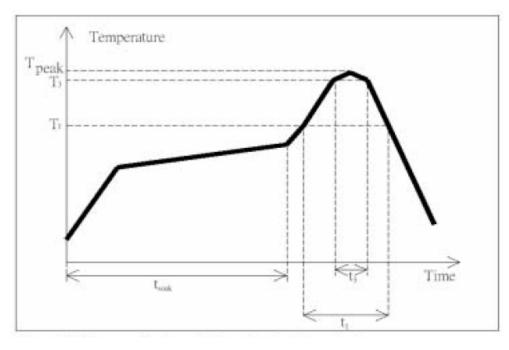


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6b. RESISTANCE TO REFLOW SOLDERING HEAT

REMOVE SPECIMEN FROM THE MOISTURE SOAK AND STORE AT ROOM TEMPERATURE FOR 15 MINUTES, NO LONGER THAN 4 HOURS AFTER REMOVAL FROM THE TEMPERATURE AND HUMIDITY EXPOSURE, SUBJECT THE SPECIMEN TO 3 CYCLES OF THE FOLLOWING REFLOW PROFILE.

Reflow profile for soldering heat resistance Testing:							
Item	Time	Specification					
Pre Heating		≦3°C/Sec					
Flux Wetting	Tsoak	2~3Min					
Time Over 217℃	t1	60~150 Sec					
Peak Temp +/-5°C	t3	20~40Sec					
Peak Time	Tpeak	250°C(-0/+5°C)					
Speed of Cooling		≦6°C/Sec					
25℃ to Peak Temp		≦8Min					



OUTLOOK OF THE JACK SHOULD HAVE NO REMARKABLE DETERIORATION. THE THE RELATIVE TEST BEFORE AND AFTER THIS TEST SHOULD COMPLIED WITH PARAGRAPH 3c.

7.**OPERATING TEMPERATURE** THE RANGE : -25 TO +70^OC

8. RATING

RATED VOLTAGE : 16 VOLTs DC RATED CURRENT : 0.3 AMPERE

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3.5 EARPHONE JACK		GE	NERAL			2012.0	1.25		5/5
	NISH						I		
TERM	MATERIA	L	COLOR		PLATING		REMA	ARK	
PLASTIC HOUSING <p1></p1>		PA		BLACK				UL94V-	0 RATED
R CONTACT <m1></m1>	COPPER					Au			20T
R SHUNT <m2></m2>	COPPER					Au			25T
T SHUNT <m3></m3>	COPPER					Au			25T
T CONTACT <m4></m4>	COPPER					Au			20T
GROUND CONTACT <m5></m5>	COPPER					Au			20T
R2 CONTACT <m6></m6>	COPPER					A11			2 0T

10. REMARK OF PARTs

				Α		С	W
				P	Richard	Н	Richard R Richard
				V		K	T
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